

116-93-328-41-001000

116-93-328-41-001000 Information

Heisener.com	 116-93-328-41-001000 Mill-Max Manufacturing Corp. Connectors, Interconnects Sockets for ICs, Transistors CONN IC DIP SOCKET 28POS GOLD - For the pricing/inventory/lead time, please contact	
For Reference Only	us Website: https://www.heisener.com E-mail: salesdept@heisener.com	Request a Quote

Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.



116-93-328-41-001000 Specifications

ManufacturerMill-Max Manufacturing Corp.CategoryConnectors, InterconnectsSeckets for ICs, TransistorsPackage-Series116TypeDIP, 0.3" (7.62mm) Row SpacingNumber of Positions or Pins (Grid)28 (2 x 14)Pitch - Mating0.100" (2.54mm)Contact Finish - MatingGoldContact Finish Thickness - Mating30µin (0.76µm)Contact Finish Thickness - MatingBeryllium CopperMounting TypeThrough HoleFeaturesElevated, Open FrameTerminationSolderContact Finish - Post1.00" (2.54mm)Contact Finish PostDil0.00" (2.54mm)Contact Finish - PostSolderContact Finish - PostSolderContact Finish - PostSolderContact Finish Thickness - PostSolderContact Finish Thickness - PostOlyuin (5.08µm)Contact Material - PostBrass AlloyPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C			
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Housing MaterialPolycyclohexylenedimethylene Terephthalate (PCT), PolyesterOperating Temperature-55°C ~ 125°C	Contact Finish Thickness - Post	200µin (5.08µm)	
Operating Temperature $-55^{\circ}C \sim 125^{\circ}C$	Contact Material - Post	Brass Alloy	
	Housing Material	Polycyclohexylenedimethylene Terephthalate (PCT), Polyester	
Report errors?	Operating Temperature	-55°C ~ 125°C	
1			Report errors?

116-93-328-41-001000 Guarantees



Quality Guarantees

We provide 90 days warranty. * If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.



Service Guarantees

We guarantee 100% customer satisfaction. Our experienced sales team and tech support team back our services to satisfy all our customers.

116-93-328-41-001000 Payment Methods





If you have any question about 116-93-328-41-001000, please do not hesitate to contact us! Website: https://www.heisener.com E-mail: salesdept@heisener.com